

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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PSE Technology Corporation

SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	25.000000 MHz
PRODUCT TYPE	TYPE FL 3.2x2.5 SEAM SEALED CRYSTAL
PART NUMBER	FL2500283Z
CUSTOMER P/N	
ISSUE DATE	September 10, 2014
VERSION	В

APPROVED	PREPARED	QA
Brenda	Niklai Lu	Bedayeri
	APPROVED BY CUSTOMER	

Please return one copy with approval to PSE-TW

PSE Technology Corporation

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- *Pb-free
- *RoHS Compliant
- *HF-Halogen Free
- *REACH Compliant

A Company of PERICOM Semiconductor Corporation

E0-R-4-014 Rev.E

VER.B 10-SEP-14

VERSION HISTORY

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
Α	Sep. 4, 2014			Initial Release	
В	Sep. 10, 2014			Updated Drive level & added C1 spec.	

VER.B 10-SEP-14

ELECTRICAL SPECIFICATIONS

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	25.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Load Capacitance	CL	20	pF	
Calibration Tolerance	FL	± 30	ppm	at 25°C±3°C
Operating Temperature Range	TR	-20 to +70	°C	
Frequency Stability	F/T	± 30	ppm	Reference to the Frequency at 25°C
Drive Level		0.01 / 100 / 500	μW	Min. / Typ. / Max.
Equivalent Series Resistance	ESR	50	Ω	Max.
Shunt Capacitance	C0	5	pF	Max.
Motional Capacitance	C1	3.1	fF	Тур.
Aging at 25°C		± 3	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	ΜΩ	Min

^{**} This product doesn"t include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a)FINE LEAK TEST: JESD22-A109 (Condition 1A)

b)GROSS LEAK TEST: JESD22-A109 (Condition C)

c)MOISTURE RESISTANCE: JESD22-A113

d)SHOCK: JESD22-B104 (Condition B)

e)SOLDERABILITY: (RoHS version): J-STD-002

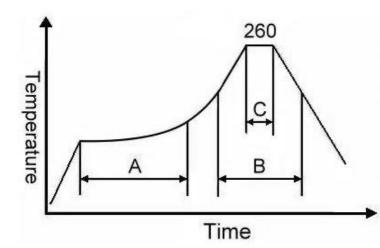
f)VIBRATION: JESD22-B103

g)SOLVENT RESISTANCE: JESD22-B107

h)RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

SUGGESTED IR REFLOW PROFILE

*As per IPC-JEDEC J-STD-020D



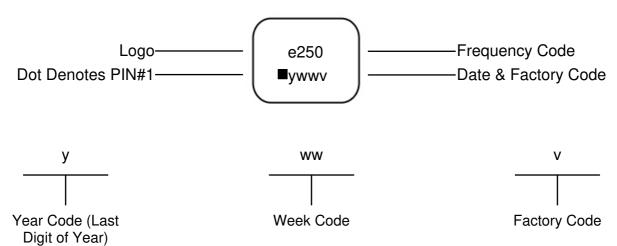
Note:

	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

For soldering reflow profile and reliability test ratings go to: http://www.pericom.com/pdf/sre/reflow.pdf

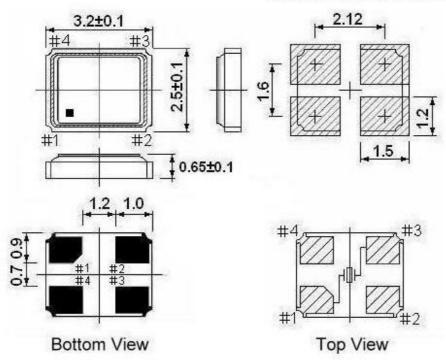
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MARKING



MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)

Recommended Land Pattern



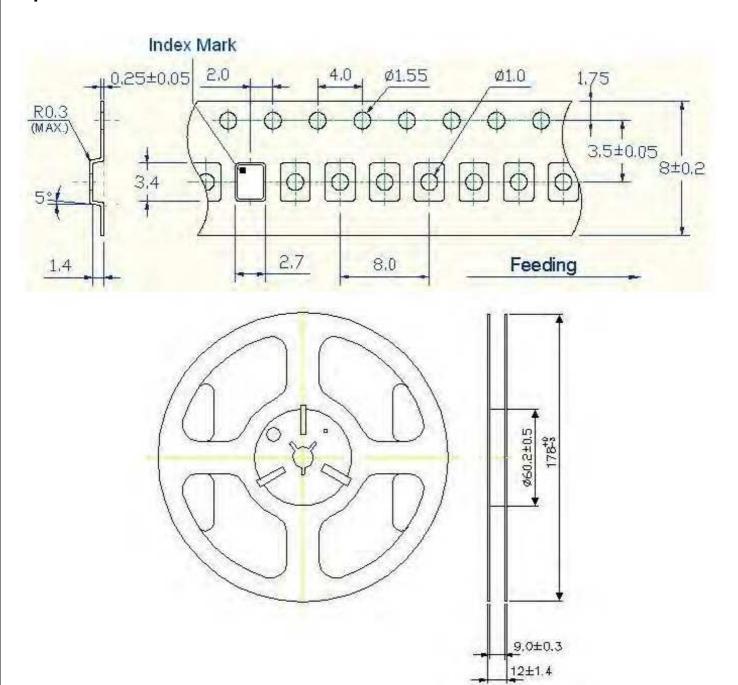
** Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

Notes:

- Package drawings are for reference only, and the appearances of objects may vary.
 Actual packages are based on the real product.
- 2. The marking dot denotes Pin#1.
- 3. The position and shape of the chamfer pin may vary and are based on the real product.

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Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

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